

## Student Membership Application Form 學生會員申請表格 ☐ Entrance △會 ☐ Data Change 更新資料 (Please refer to the Notes on Student Membership Application 請參閱「學生會員申請細則」)

2104 Shanghai Industrial Investment Building, 48 Hennessy Road, Wan Chai, Hong Kong ● 香港灣仔軒尼詩道 48 號上海實業大廈 2104 Tel 電話: (852) 2889 9986 Fax 傳真: (852) 2889 9982 E-mail 電郵: executive@hkiod.com Web-site 網頁: www.hkiod.com

Mr / Mrs / Miss / Ms / Dr / Prof / Ir 英文稱號			Name in Chin	Name in Chinese 中文姓名  Sex 性別  Honours/Designations after Name 姓之  Forenames 英文名字		Honours/D	esignations after Name 姓名後名街
Surname 英文姓氏		Forenames 身					
ormat of Name	in Corresponde	ence 函件上採用的芽					
Date of Birth 出生日期(day/mth/yr 日/月/年)			HK ID Card N	HK ID Card No. 香港身份證號碼		Nationality 國籍	
Correspondence	e Address 聯絡	 英文地址					
el 電話:				Fax 傳真:			
lome Address	住宅英文地址	(if different from above	/e 如與上址不下				
「el 電話:				Fax 傳真:			
Email 電郵				1 00. 14 57			
		and Profession					
From 由	To 至	Institution, University School Name 機構、大學、學院	3		ed / Qualifications O f獲資格或學歷		Honours & Awards / Extra-curricular Activi 榮譽及獎勵 / 課外活動
				<u> </u>			
		. //6					
Section 3:	: Work Exp	eriences (if app	licable) エ	作經驗 (如道	適用) ————		
Applicant's Exp	perience 申請丿	(年資: Total Work	Experience 全部	『工作經驗	Years 年		
From 由		To 至		Company Name	公司名稱		Position Held 職位
Section 4	: Profile Of	Current Princip	al Compan	y (if applicabl	ie) 現時所屬	主要公	司資料 (如適用)
Name of Current Principal Company in English and Chinese 現時所屬主要公司英文及中文名稱					Co Legal Status 公司法律地位 (Code 代號**)		English and Chinese 及中文名稱
Company Main Activity (in 30 English characters maximum including spaces) 公司主要業務(以最多 15 中文字簡述)				aces)	No. of Board Me  □ < 5		董事人數 5-10 □ > 10
					No. of Employer	es公司僱員	1 申/-



Student Membership Application Form 學生會員申請表格 Applicant's Name 申請人姓名:

Date 日期:\_\_\_\_\_

S	ectio	n 5: Group Organisation 集體組織					
Gro	up or C	Organisation Name 組別或組織名稱:	Contact Person & Tel 聯絡人及電話號碼				
S	ectio	n 6: Declaration 宣言					
(a)	學生 (i) (ii)	會員,並同意遵守學會之:- Articles of Association and 《公司章程細則》及	rectors and agree to be bound by the Institute's 本人現申請成為香港董事學會之 nduct and fulfillment of annual Continuing Professional Development.「會員評鑒制修。Details from 詳情載於http://hkiod.com/accreditation.html.				
(b)	I con	firm that I have not been disqualified by Court Order from being a dir	ector. 本人確認不曾被法庭取消擔任董事資格。				
(c)	I have read and understand the following declaration regarding personal data collection:- 本人已閱讀並明白下列有關個人資料蒐集的宣言:一 "The Hong Kong Institute of Directors has adopted a Personal Data (Privacy) Policy, full details of which are downloadable from http://www.hkiod.com/statement.html. Data subjects have a right of access and correction regarding their respective personal data. Data subjects who do not wish to receive communications may notify the Institute in writing. Requests can be directed to the Institute by post at 2104 Shanghai Industrial Investment Building, 48 Hennessy Road, Wan Chai, Hong Kong, or by email at personaldata@hkiod.com, or by fax at +852 2889 9982. For inquiries, telephone +852 2889 9986. Personal data collected by this document will be used to process application for membership and facilitate communications by post, email, telephone and fax." 「香港董事學會訂定個人資料(私隱)政策,其詳細內容可從 http://www.hkiod.com/chn/statement.html 網頁一載。資料當事人有權查閱及更正其相關個人資料。資料當事人如擬停止收取通訊,可以書面方式向學會提出,郵寄香港灣仔軒尼詩道48 號上海實業大廈 2104、或電郵至 personaldata@hkiod.com、或傳真至+852 2889 9982。查詢電話+852 2889 9986,此表格蒐集個人資料。目的為處理入會申請,並提供聯絡資料以透過郵遞、電郵、電話、傳真通訊。」						
(d)	servi		irectors to regularly communicate with me on updates, events, projects, membership, option by inserting ✓ in the box:- 本人明白及接受香港董事學會定期通知我有 訊,也明白本人可以在方格內加上"✓"號選擇如下:				
		I DO NOT wish to receive above communications from the Institute	<ol> <li>本人不願意接收學會的以上資訊。</li> </ol>				
(e)	I understand that upon admission to membership, the Institute will include my name, company and position on its Welcome List emailed to members. I indicate by ✓ my options as follows:-本人理解當我加入會籍後,學會將以電郵方式傳閱《歡迎名單》,當中包含我的姓名、公司及職稱。我以✓選擇:─						
		I opt to be EXCLUDED from the Welcome List. 我不願意被列	入《歡迎名單》中。				

## Section 7: Sponsor 推薦人 (to be completed by the Sponsor 由推薦人填寫)

Sponsor Name 推薦人姓名:	Tel 電話:			
	Fax 傳真:			
I, being HKIoD member, hereby propose the applicant. 本人現時乃香港董事學會之會員,特推薦上述申請人。				
Signature 簽名:	Date 日期:			

## Section 8: Completion of Application Form 完成申請表格

Signature 簽名:\_\_\_\_\_

[Please check and ✓ items enclosed. 請√下列各項。]				
* ************************************				
	A photograph with name at the back (no glue or staples). 相片一幀背面書寫姓名但請勿用黏膠或書釘。			
	A business card (if applicable). 名片一幀(如適用)。			